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In case of consideration for using Automotive equipment / device which demand high reliability, kindly contact our sales window correspondents.

TO

COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE	COUNT	DESCRIPTION OF REVISIONS	BY	CHKD	DATE
△					△				
△					△				
APPLICABLE STANDARD									
RATING	OPERATING TEMPERATURE RANGE	-30°C TO +85 °C(NOTE1)			STORAGE TEMPERATURE RANGE	-10°C TO +60°C(NOTE2)			
	VOLTAGE	250 V AC			CURRENT	3 A			
SPECIFICATIONS									
ITEM		TEST METHOD			REQUIREMENTS			QT	AT
CONSTRUCTION									
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.			ACCORDING TO DRAWING.			X	X
MARKING		CONFIRMED VISUALLY.						X	X
ELECTRIC CHARACTERISTICS									
CONTACT RESISTANCE		100 mA (DC OR 1000 Hz).			30 mΩ MAX.			X	—
INSULATION RESISTANCE		500 V DC.			1000MΩ MIN.			X	—
VOLTAGE PROOF		650V AC FOR 1 min.			NO FLASHOVER OR BREAKDOWN.			X	—
MECHANICAL CHARACTERISTICS									
MECHANICAL OPERATION		30 TIMES INSERTIONS AND EXTRACTIONS.			① CONTACT RESISTANCE: 30 mΩ MAX. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			X	—
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.			① NO ELECTRICAL DISCONTINUITY OF 1μs.			X	—
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.			② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			X	—
ENVIRONMENTAL CHARACTERISTICS									
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55→ 5~35 →+85→ 5~35 °C TIME 30→10~15→ 30 →10~15 min UNDER 5 CYCLES.			① CONTACT RESISTANCE: 30 mΩ MAX. ② INSULATION RESISTANCE: 1000 MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			X	—
DAMP HEAT (STEADY STATE)		EXPOSED AT 40 ± 2 °C, 90 ~ 95 %, 96 h.			① CONTACT RESISTANCE: 30 mΩ MAX. ② INSULATION RESISTANCE: 1000 MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.			X	—
RESISTANCE TO SOLDERING HEAT		SOLDER TEMPERATURE, 250±5°C, FOR IMMERSION, DURATION, 10 s.			NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.			X	—
SOLDERABILITY		SOLDERED AT SOLDER TEMPERATURE, 230±5 °C FOR INSERTION DURATION, 5 s.			SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.			X	—
REMARKS									
NOTE1:INCLUDING THE TEMPERATURE RISE BY CURRENT. NOTE2:APPLY TO THE CONDITION OF LONG TERM STORAGE FOR UNUSED PRODUCTS BEFORE PCB ON BOARD, AFTER PCB BOARD,OPERATING TEMPERATURE AND HUMIDITY RANGE IS APPLIED FOR INTERIM STORAGE DURING TRANSPORTATION. Unless otherwise specified, refer to JIS C 5402.					DRAWN	DESIGNED	CHECKED	APPROVED	RELEASED
					M.Nakamoto '04.04.16	H. Umehara 04.04.16	J. Ono 04.04.16	J. Ono 04.04.16	
Note QT:Qualification Test AT:Assurance Test X:Applicable Test									
HRS HIROSE ELECTRIC CO., LTD.					SPECIFICATION SHEET			PART NO. DF1-*P-2. 5DSA (05)	
CODE NO.(OLD) CL		DRAWING NO. ELC4-162342-10			PART NO. CL541			1/1	

